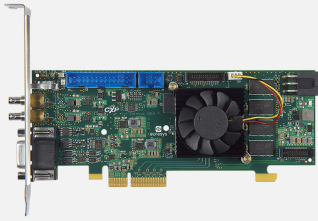


Coaxlink Duo CXP-12

Two-connection CoaXPress CXP-12 frame grabber



At a Glance

- Two CoaXPress CXP-12 connections: 2,500 MB/s camera bandwidth
- PCIe 3.0 (Gen 3) x4 bus: 3,300 MB/s bus bandwidth
- Low-profile card. Delivered with standard and low-profile brackets.
- Fan-cooled heatsink
- Feature-rich set of 10 digital I/O lines
- Extensive camera control functions
- Memento Event Logging Tool

Benefits

Low-profile PCIe card

- Delivered with standard and low-profile brackets

PCIe 3.0 (Gen 3) x4 bus

- 3,300 MB/s sustained bus bandwidth

Acquire images from the fastest and highest resolution cameras

- Highest data acquisition rate in the industry
- 25 Gbit/s (2,500 MB/s) bandwidth from camera to host PC memory

Long cable support for Coaxlink CXP-12

- 40 meters at CXP-12 speed (12.5 Gbps)
- 72 meters at CXP-6 speed (6.25 Gbps)
- 100 meters at CXP-3 speed (3 Gbps)

Use standard coaxial cables

- A single inexpensive cable for data transfer, camera control, trigger and power supply
- Top reliability and flexibility, performs in the harshest environments

Robust connectors

- Micro-BNC (HD-BNC™) connectors for reliable connection
- Trusted push and turn, bayonet-style positive lock
- Allows for quick and easy connects and disconnects

Memento Event Logging Tool

- Memento is an advanced development and debugging tool available for Coaxlink cards.
- Memento records an accurate log of all the events related to the camera, the frame grabber and its driver as well as the application.
- It provides the developer with a precise timeline of time-stamped events, along with context information and logic analyzer view.
- It provides valuable assistance during application development and debugging, as well as during machine operation.

Direct GPU transfer

- Sample programs for AMD DirectGMA and NVIDIA (CUDA) available.
- Direct GPU transfer eliminates unnecessary system memory copies, lowers CPU overhead, and reduces latency, resulting in significant performance improvements in data transfer times for applications.
- Direct capture of image data to GPU memory is available using AMD's DirectGMA. Compatible with AMD FirePro W5x00 and above and all AMD FirePro S series products.

General purpose I/O lines

- Compatible with a wide range of sensors and motion encoders.
- High-speed differential inputs: Quadrature motion encoder support up to 5 MHz.
- Isolated current-sense inputs: 5V, 12V, 24V signaling voltages accepted, up to 50 kHz, individual galvanic isolation up to 250VDC and 170VAC RMS.
- Isolated contact outputs.
- High-speed 5V-compliant TTL inputs/ LVTTTL outputs.

High-performance DMA (Direct Memory Access)

- Direct transfer into user-allocated memory and hardware boards that expose PCI addresses
- Hardware scatter-gather support
- 64-bit addressing capability

Area-scan triggering capabilities

- A trigger is used to start the acquisition when the part is in position. Hardware triggers come from the Coaxlink's I/O lines. Software triggers come from the application.
- An optional trigger delay is available to postpone the acquisition for a programmable time.
- A trigger decimation function allows to skip some of the triggers.
- Camera exposure control allows the application to control the exposure time of the camera.
- When the acquisition starts, at the appropriate timing, the Coaxlink board generates a signal to control an illumination device connected to one of its output lines.

The Coaxlink driver includes the following tools:

- Genicam Browser: An application giving access to the Genicam features exposed by the GenTL Producer(s) in the system.
- GenTL Console: A command-line tool giving access to the functions and commands exposed by the Euresys GenTL Producer.

Compliant with Genicam Including support for

- GenApi
- The Standard Feature Naming Convention (SFNC)
- GenTL

Windows, Linux and macOS drivers available

- Including support for Intel 32-bit and 64-bit platforms as well as ARM 64-bit platforms

Applications

Machine Vision for the Electronic Manufacturing Industry

- High speed image acquisition for AOI, 3D SPI, 3D lead/ball inspection machines.
- Very high resolution line-scan image acquisition for Flat Panel Display inspection and solar cell inspection
- Mark inspection

Machine Vision for the General Manufacturing Industries

- High frame rate image acquisition for inspection machines
- Line-scan image acquisition for surface inspection machines
- Line-scan image acquisition for textile inspection
- Image acquisition for robots

Machine Vision for the Printing Industry

- High speed line-scan image acquisition for printing inspection machines

Video Acquisition and Recording

- High-frame-rate video acquisition for motion analysis and recording

Video Monitoring, Surveillance & Security

- Transmission and acquisition of high-definition video over long coaxial cables for traffic surveillance, monitoring and control

Specifications

Mechanical

Format	Low profile, half length, 4-lane PCI Express card
Cooling method	Air cooling, fan-cooled heatsink
Mounting	<ul style="list-style-type: none">• For insertion in a 4-lane or higher, PCI Express card slot.• Delivered with standard- and low-profile brackets for insertion in a standard- or a low-profile chassis.
Connectors	<ul style="list-style-type: none">• 'A', 'B' on bracket:<ul style="list-style-type: none">– Micro-BNC female connectors– CoaXPress host interface• 'EXTERNAL I/O 1' on bracket:<ul style="list-style-type: none">– 15-pin 3-row high-density female sub-D connector– I/O lines and power output• 'INTERNAL I/O 1' on PCB:<ul style="list-style-type: none">– 26-pin 2-row 0.1" pitch pin header with shrouding– I/O lines and power output• 'I/O EXTENSION' on PCB:<ul style="list-style-type: none">– 26-pin 2-row 0.05" pitch pin header with shrouding– I/O extension lines and power output• 'AUXILIARY POWER INPUT' on module:<ul style="list-style-type: none">– 6-pin PEG power socket– 12 VDC power input for PoCXP camera(s) and I/O power• 'C2C-LINK' on module:<ul style="list-style-type: none">– 6-pin 2-row 0.1" header– Card to card link

LED indicators	<ul style="list-style-type: none"> • 'A', 'B' on bracket: <ul style="list-style-type: none"> – Bi-color red/green LEDs – CoaXPress Host connector indicator • 'FPGA STATUS LAMP' on PCB: <ul style="list-style-type: none"> – Bi-color red/green LED – FPGA status indicator • 'BOARD STATUS LAMP' on PCB: <ul style="list-style-type: none"> – Bi-color red/green LED – Board status indicator
Switches	<p>'RECOVERY' on card PCB:</p> <ul style="list-style-type: none"> • 3-pin 1-row 0.1" header • Firmware emergency recovery
Dimensions	<p>L 167.65 mm x H 68,90 mm</p> <p>L 6.6 in x H 2.71 in</p>
Weight	125g, 4.40 oz

Host bus

Standard	PCI Express 3.0
Link width	<ul style="list-style-type: none"> • 4 lanes • 1 lane or 2 lanes with reduced performance
Link speed	<ul style="list-style-type: none"> • 8.0 GT/s (PCIe 3.0) • 5.0 GT/s (PCIe 2.0) with reduced performance
Maximum payload size	512 bytes
DMA	32- and 64-bit
Peak delivery bandwidth	3,900 MB/s
Effective (sustained) delivery bandwidth	3,350 MB/s (Host PC motherboard dependent)
Power consumption	Typ. 14.8 W (4.3W @ 3.3V + 10.5 W @12V), excluding camera and I/O power output

Camera / video inputs

Interface standard(s)	CoaXPress 1.0, 1.1, 1.1.1 and 2.0
Connectors	Two micro-BNC 75 Ohms (also known as HD-BNC™) CXP-12
Status LEDs	One CoaXPress Host connection status LED per connector
Number of cameras	<ul style="list-style-type: none"> • Area-scan cameras: <ul style="list-style-type: none"> – One 1- or 2-connection camera – One or two 1-connection cameras
Maximum aggregated camera data transfer rate	25 Gbit/s (2,500 MB/s)
Supported CXP down-connection speeds	<p>1.25 GT/s (CXP-1), 2.5 GT/s (CXP-2), 3.125 GT/s (CXP-3), 5 GT/s (CXP-5), 6.25 GT/s (CXP-6), 10.0 GT/s (CXP-10)*, and 12.5 GT/s (CXP-12)*</p> <p>NOTE: mixing CXP-10 and CXP-12 is not allowed!</p>
Supported CXP up-connection speeds	<ul style="list-style-type: none"> • Low-speed 20.83* Mbps (CXP-1 to CXP-6) • Low-speed 41.6* Mbps (CXP-10, CXP-12)
Number of CXP data streams (per camera)	1 data stream per camera
Maximum CXP stream packet size	16,384 bytes

PoCXP (Power over CoaXPress)	<ul style="list-style-type: none"> • PoCXP Safe Power: <ul style="list-style-type: none"> – 17 W of 24V DC regulated power per CoaXPress connector – PoCXP Device detection and automatic power-on – Overload and short-circuit protections • On-board 12V to 24V DC/DC converter • A +12V power source must be connected to the AUXILIARY POWER INPUT connector using a 6-pin PEG cable
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Camera types	<ul style="list-style-type: none"> • Area-scan cameras: <ul style="list-style-type: none"> – Gray-scale and color (RGB and Bayer CFA) – Single-tap (1X-1Y) progressive-scan
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Camera pixel formats supported	Raw, Monochrome, Bayer, RGB, and RGBA (PFNC names): <ul style="list-style-type: none"> • Raw • Mono8, Mono10, Mono12, Mono14, Mono16 • BayerXX8, BayerXX10, BayerXX12, BayerXX14, BayerXX16 where XX = GR, RG, GB, or BG • RGB8, RGB10, RGB12, RGB14, RGB16 • RGBA8, RGBA10, RGBA12, RGBA14, RGBA16 • YCbCr601_422_8, YCbCr601_422_10 • YCbCr709_422_8, YCbCr709_422_10 • YUV422_8, YUV422_10
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Area-scan camera control

Trigger	<ul style="list-style-type: none"> • Precise control of asynchronous reset cameras, with exposure control. • Support of camera exposure/readout overlap. • Support of external hardware trigger, with optional delay and trigger decimation.
Strobe	<ul style="list-style-type: none"> • Accurate control of the strobe position for strobed light sources. • Support of early and late strobe pulses.

On-board processing

On-board memory	1 GB
Image data stream processing	<ul style="list-style-type: none"> • Unpacking of 10-/12-/14-bit to 16-bit with selectable justification to LSb or MSb • Optional swap of R and B components • Little endian conversion
Input LUT (Lookup Table)	Only available for monochrome cameras: <ul style="list-style-type: none"> • 8 to 8 bits • 10 to 8, 10 or 16 bits • 12 to 8, 12 or 16 bits
Bayer CFA to RGB decoder	<ul style="list-style-type: none"> • '1-camera' firmware variant: <ul style="list-style-type: none"> – 5x5 gradient-based interpolation method
Data stream statistics	<ul style="list-style-type: none"> • Measurement of: <ul style="list-style-type: none"> – Frame rate (Area-scan only) – Line rate – Data rate • Configurable averaging interval

Event signaling and counting

- The application software can be notified of the occurrence of various events:
 - Standard event: the EVENT_NEW_BUFFER event notifies the application of newly filled buffers
 - A large set of custom events
- Custom events sources:
 - I/O Toolbox events
 - Camera and Illumination control events
 - CoaXPress data stream events
 - CoaXPress host interface events
- Each custom event is associated with a 32-bit counter that counts the number of occurrences
- The last three 32-bit context data words of the event context data can be configured with event-specific context data:
 - Event-specific data
 - State of all System I/O lines sampled at the event occurrence time
 - Value of any event counter

General Purpose Inputs and Outputs

Number of lines	<p>10 I/O lines:</p> <ul style="list-style-type: none">• 2 differential inputs (DIN)• 2 singled-ended TTL inputs/outputs (TTLIO)• 4 isolated inputs (IIN)*• 2 isolated outputs (IOUT)* <p>NOTE: Only 2 IIN and 1 IOUT lines are available on the EXTERNAL I/O connector.</p> <p>NOTE: The number of I/O lines can be extended using I/O modules attached to the I/O EXTENSION connector.</p>
Usage	<ul style="list-style-type: none">• Any I/O input lines can be used by any LIN tool of the I/O Toolbox• Selected pairs of I/O input lines can be used by any QDC tool of the I/O toolbox to decode A/B signals of a motion encoder• The LIN and QDC tools outputs can be further processed by the other tools (DIV, MDV, DEL) of the I/O toolbox to generate any of the following "trigger" events:<ul style="list-style-type: none">– The "cycle trigger" of the Camera and Illumination controller– The "cycle sequence trigger" of the Camera and Illumination controller
Electrical specifications	<ul style="list-style-type: none">• DIN: High-speed differential inputs compatible with ANSI/EIA/TIA-422/485 differential line drivers and complementary TTL drivers• TTLIO: High-speed 5V-compliant TTL inputs or LVTTTL outputs, compatible with totem-pole LVTTTL, TTL, 5V CMOS drivers or LVTTTL, TTL, 3V CMOS receivers• IIN: Isolated current-sense inputs with wide voltage input range up to 30V, compatible with totem-pole LVTTTL, TTL, 5V CMOS drivers, RS-422 differential line drivers, potential free contacts, solid-state relays and opto-couplers• IOUT: Isolated contact outputs compatible with 30V / 100mA loads
Filter control	<ul style="list-style-type: none">• Glitch removal filter available on all System I/O input lines• Configurable filter time constants:<ul style="list-style-type: none">– for DIN and TTLIO lines: 50 ns, 100 ns, 200 ns, 500 ns, 1 μs– for IIN lines: 500 ns, 1 μs, 2 μs, 5 μs, 10 μs
Polarity control	Yes
Power output	Non-isolated, +12V, 1A, with electronic fuse protection

I/O Toolbox tools

The I/O Toolbox is a configurable interconnection of tools that generates events (usually triggers) from input lines. The composition of the toolset is product- and firmware-dependent.

- Line Input tool (LIN): Edge detector delivering events on rising or falling edges of any selected input line.
- Quadrature Decoder tool (QDC): A composite tool including:
 - A quadrature edge detector delivering events on selected transitions of selected pairs of input lines.
 - An optional backward motion compensator for clean line-scan image acquisition when the motion is unstable.
 - A 32-bit up/down counter for delivering a position value.
- Divider tool (DIV): to generate an event every nth input events from any I/O toolbox event source.
- Multiplier/divider tool (MDV): to generate m events every d input events from any I/O toolbox event source.
- Delay tool (DEL): to delay up to 16 events from one or two I/O toolbox event sources, by a programmable time or number of motion encoder ticks (any QDC events).
- User Actions Scheduler tool (UAS): to delegate the execution of User Actions at a scheduled time or encoder position. Possible user actions include setting low/high/toggle any bit of the User Output Register or generation of any User Events.

I/O Toolbox composition

Determined by the selected firmware variant:

- 1-camera: 8 LIN, 1 QDC, 1 DIV, 1 MDV, 2 DEL, 1 UAS
 - 2-camera: 8 LIN, 2 QDC, 2 DIV, 2 MDV, 2 DEL, 1 UAS
-

C2C-Link

Description

- Accurate synchronization of the trigger and the start-of-exposure of multiple grabber-controlled area-scan cameras.
 - Accurate synchronization of the start-of-cycle, start-of-scan and end-of-scan of multiple grabber-controlled line-scan cameras.
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Specification

- C2C-Link synchronizes cameras connected to:
 - the same card
 - to different cards in the same PC (requires an accessory cable such as the "3303 C2C-Link Ribbon Cable" or a custom-made C2C-Link cable)
 - to different cards in different PCs (requires one "1636 InterPC C2C-Link Adapter" for each PC and one RJ 45 CAT 5 STP straight LAN cable for each adapter but the last one)
 - Maximum distance:
 - 60 cm inside a PC
 - 1200 m cumulated adapter to adapter cable length
 - Maximum trigger rate:
 - 2.5 MHz for configurations using a single PC, or up to 10 PCs and 100 m total C2C-Link cable length
 - 200 kHz for configurations up to 32 PCs and 1200m total C2C-Link cable length
 - Trigger propagation delay from master to slave devices:
 - Less than 10 ns for cameras on the same card or on different Coaxlink cards in the same PC
 - Less than 265 ns for cameras on different cards in different PCs (3 PCs and 40m total C2C-Link cable length)
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Software

Host PC Operating System	<ul style="list-style-type: none">• Microsoft Windows 10, 8.1, 7 for x86 (32-bit) and x86-64 (64-bit) processor architectures• Linux for x86 (32-bit), x86-64 (64-bit) and aarch64 (64-bit) processor architectures• macOS for x86-64 (64-bit) processor architecture <p>Refer to release notes for details</p>
APIs	<p>EGrabber class, with C++ and .NET APIs:</p> <ul style="list-style-type: none">• .NET assembly designed to be used with development environments compatible with .NET frameworks version 4.0 or higher <p>GenICam GenTL producer libraries compatible with C/C++ compilers:</p> <ul style="list-style-type: none">• x86 dynamic library designed to be used with ISO-compliant C/C++ compilers for the development of x86 applications• x86_64 dynamic library designed to be used with ISO-compliant C/C++ compilers for the development of x86_64 applications• aarch64 dynamic library designed to be used with ISO-compliant C/C++ compilers for the development of aarch64 applications

Environmental conditions

Operating ambient air temperature	0 to +55 °C / +32 to +131 °F
Operating ambient air humidity	10 to 90% RH non-condensing
Storage ambient air temperature	-20 to +70 °C/ -4 to +158 °F
Storage ambient air humidity	10% to 90% RH non-condensing

Certifications

Electromagnetic - EMC standards	<ul style="list-style-type: none">• European Council EMC Directive 2004/108/EC• United States FCC rule 47 CFR 15
EMC - Emission	<ul style="list-style-type: none">• EN 55022:2010 Class B• FCC 47 Part 15 Class B
EMC - Immunity	<ul style="list-style-type: none">• EN 55024:2010 Class B• EN 61000-4-3• EN 61000-4-4• EN 61000-4-6
KC Certification	Korean Radio Waves Act, Article 58-2, Clause 3
Flammability	PCB compliant with UL 94 V-0
RoHS	European Union Directive 2015/863 (ROHS3)
REACH	European Union Regulation 1907/2006
WEEE	Must be disposed of separately from normal household waste and must be recycled according to local regulations

Ordering Information

Product code - Description	<ul style="list-style-type: none">• 3622 - Coaxlink Duo CXP-12
Optional accessories	<ul style="list-style-type: none">• 1625 - DB25F I/O Adapter Cable• 1636 - InterPC C2C-Link Adapter• 3303 - C2C-Link Ribbon Cable• 3304 - HD26F I/O Adapter Cable• 3610 - HD26F I/O Extension Module TTL-RS422• 3612 - HD26F I/O Extension Module TTL-CMOS5V-RS422• 3614 - HD26F I/O Extension Module - Standard I/O Set



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